



# PHPT60415NY-Q

40 V, 15 A NPN high power bipolar transistor

27 September 2024

Product data sheet

## 1. General description

NPN high power bipolar transistor in a SOT669 (LFAK56) Surface-Mounted Device (SMD) power plastic package.

PNP complement: PHPT60415PY-Q

## 2. Features and benefits

- High thermal power dissipation capability
- High temperature applications up to 175 °C
- Reduced Printed Circuit Board (PCB) requirements comparing to transistors in DPAK
- High energy efficiency due to less heat generation
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Power management
- Load switch
- Linear mode voltage regulator
- Backlighting applications
- Motor drive
- Relay replacement

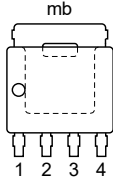
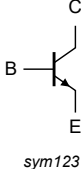
## 4. Quick reference data

Table 1. Quick reference data

| Symbol      | Parameter                               | Conditions  | Min | Typ | Max | Unit       |
|-------------|---|---|-----|-----|-----|------------|
| $V_{CEO}$   | collector-emitter voltage               | open base   | -   | -   | 40  | V          |
| $I_C$       | collector current                       |   | -   | -   | 15  | A          |
| $I_{CM}$    | peak collector current                  | single pulse; $t_p \leq 1$ ms   | -   | -   | 30  | A          |
| $R_{CEsat}$ | collector-emitter saturation resistance | $I_C = 15$ A; $I_B = 1.5$ A; pulsed; $t_p \leq 300$ $\mu$ s; $\delta \leq 0.02$ ; $T_{amb} = 25$ °C | -   | 28  | 40  | m $\Omega$ |

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline  | Graphic symbol  |
|-----|--------|-------------|---|---|
| 1   | E      | emitter     |  <p><b>LFPAK56; Power-SO8 (SOT669)</b></p> |  <p>sym123</p> |
| 2   | E      | emitter     |   |   |
| 3   | E      | emitter     |   |   |
| 4   | B      | base        |   |   |
| mb  | C      | collector   |   |   |

## 6. Ordering information

Table 3. Ordering information

| Type number                   | Package               |  |                        |
|-------------------------------|-----------------------|--|------------------------|
|                               | Name                  | Description  | Version                |
| <a href="#">PHPT60415NY-Q</a> | LFPAK56;<br>Power-SO8 | plastic, single-ended surface-mounted package; 4 terminals | <a href="#">SOT669</a> |

## 7. Marking

Table 4. Marking codes

| Type number   | Marking code |
|---------------|--------------|
| PHPT60415NY-Q | 0415NAB      |

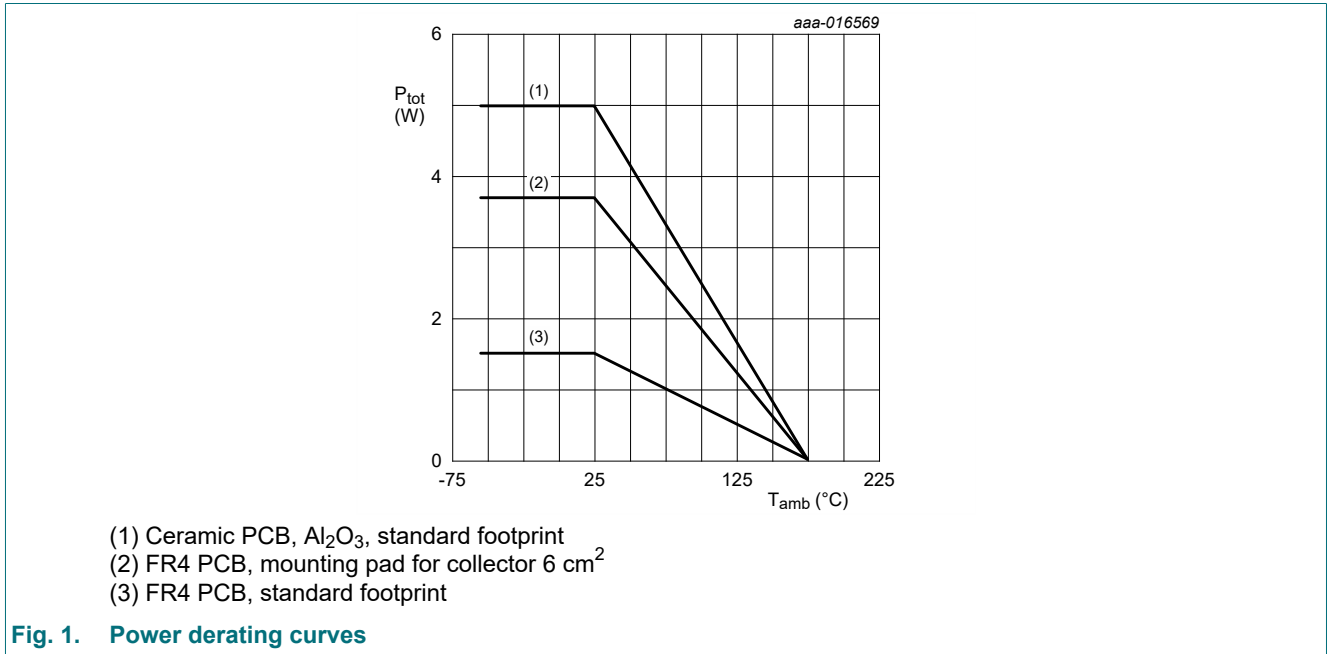
## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol    | Parameter                 | Conditions                    | Min | Max | Unit |   |
|-----------|---------------------------|-------------------------------|-----|-----|------|---|
| $V_{CBO}$ | collector-base voltage    | open emitter                  | -   | 40  | V    |   |
| $V_{CEO}$ | collector-emitter voltage | open base                     | -   | 40  | V    |   |
| $V_{EBO}$ | emitter-base voltage      | open collector                | -   | 7   | V    |   |
| $I_C$     | collector current         |                               | -   | 15  | A    |   |
| $I_{CM}$  | peak collector current    | single pulse; $t_p \leq 1$ ms | -   | 30  | A    |   |
| $I_B$     | base current              |                               | -   | 1.5 | A    |   |
| $I_{BM}$  | peak base current         | single pulse; $t_p \leq 1$ ms | -   | 3   | A    |   |
| $P_{tot}$ | total power dissipation   | $T_{amb} \leq 25$ °C          | [1] | -   | 1.5  | W |
|           |                           |                               | [2] | -   | 3.7  | W |
|           |                           |                               | [3] | -   | 5    | W |
|           |                           |                               | [4] | -   | 25   | W |
| $T_j$     | junction temperature      |                               | -   | 175 | °C   |   |
| $T_{amb}$ | ambient temperature       |                               | -55 | 175 | °C   |   |
| $T_{stg}$ | storage temperature       |                               | -65 | 175 | °C   |   |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated and mounting pad for collector 6 cm<sup>2</sup>.
- [3] Device mounted on an ceramic PCB; Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [4] Power dissipation from junction to mounting base.



**Fig. 1. Power derating curves**

## 9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol         | Parameter   | Conditions  |     | Min | Typ | Max | Unit |
|----------------|---|-------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient       | in free air | [1] | -   | -   | 100 | K/W  |
|                |   |             | [2] | -   | -   | 41  | K/W  |
|                |   |             | [3] | -   | -   | 30  | K/W  |
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base |             |     | -   | -   | 6   | K/W  |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for collector 6 cm<sup>2</sup>.
- [3] Device mounted on an ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

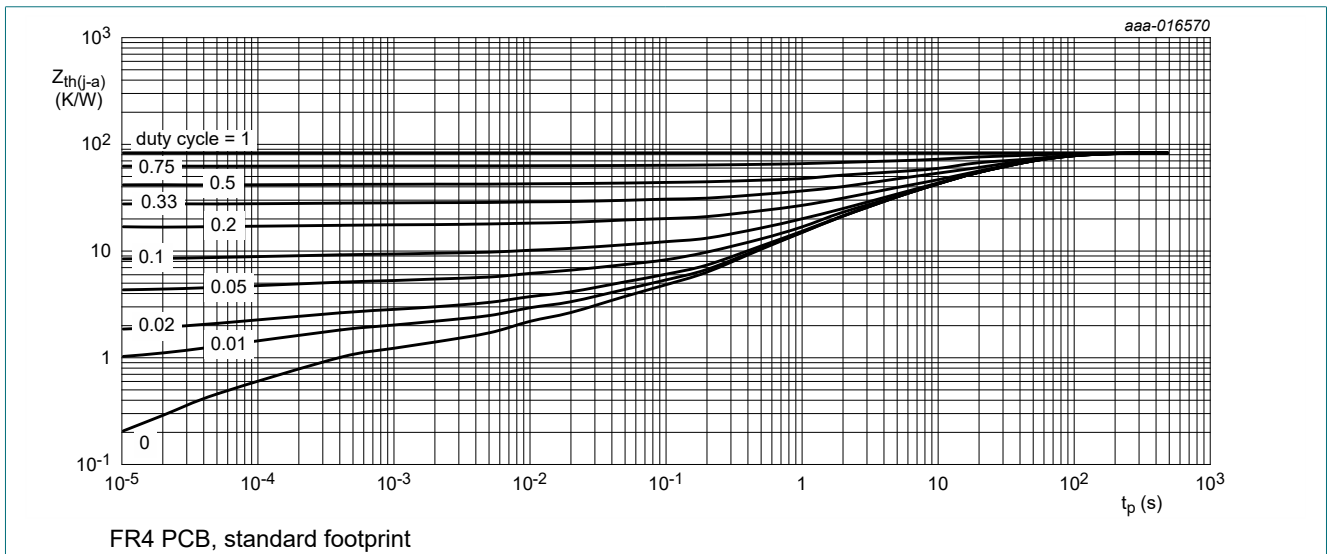


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

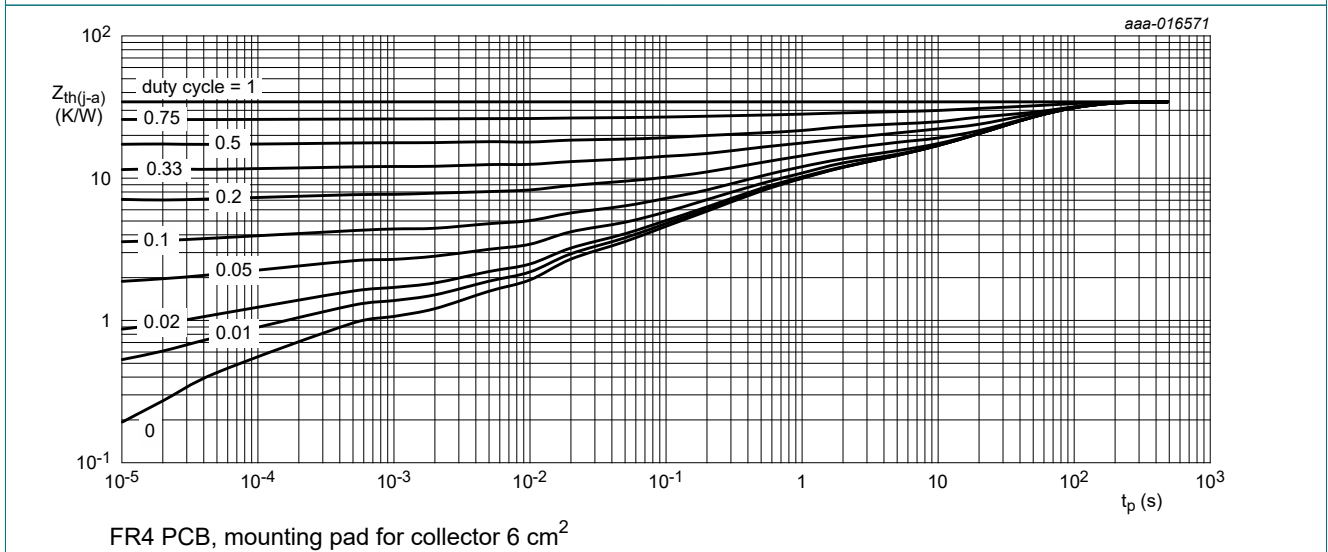
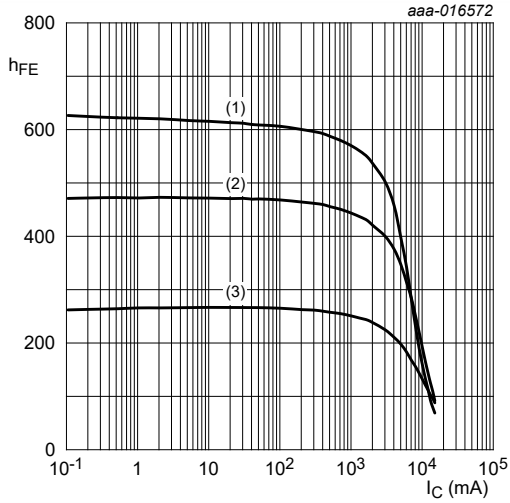


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

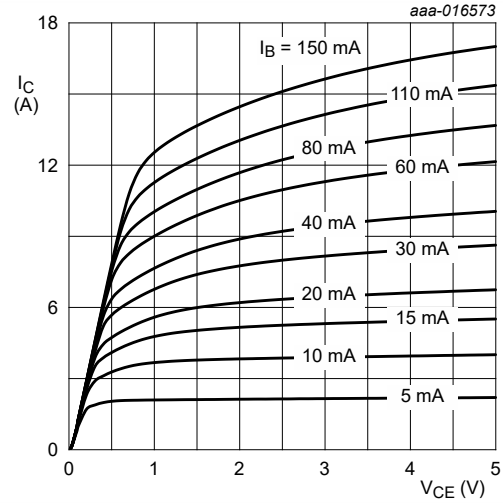
Table 7. Characteristics

| Symbol      | Parameter                               | Conditions  | Min   | Typ | Max  | Unit          |
|-------------|---|---|---|-----|------|---------------|
| $I_{CBO}$   | collector-base cut-off current          | $V_{CB} = 32 \text{ V}; I_E = 0 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$   | -   | -   | 100  | nA            |
|             |   | $V_{CB} = 32 \text{ V}; I_E = 0 \text{ A}; T_J = 150 \text{ }^\circ\text{C}$  | -   | -   | 50   | $\mu\text{A}$ |
| $I_{CES}$   | collector-emitter cut-off current       | $V_{CE} = 32 \text{ V}; V_{BE} = 0 \text{ V}; T_{amb} = 25 \text{ }^\circ\text{C}$  | -   | -   | 100  | nA            |
| $I_{EBO}$   | emitter-base cut-off current            | $V_{EB} = 7 \text{ V}; I_C = 0 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$  | -   | -   | 100  | nA            |
| $h_{FE}$    | DC current gain                         | $V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$   | 250   | 410 | -    |               |
|             |   | $V_{CE} = 2 \text{ V}; I_C = 1 \text{ A}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$                 | 250   | 400 | -    |               |
|             |   | $V_{CE} = 2 \text{ V}; I_C = 10 \text{ A}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$                | 100   | 160 | -    |               |
|             |   | $V_{CE} = 2 \text{ V}; I_C = 15 \text{ A}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}; \text{pulsed}$ | 50  | 80  | -    |               |
| $V_{CEsat}$ | collector-emitter saturation voltage    | $I_C = 1 \text{ A}; I_B = 50 \text{ mA}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}; \text{pulsed}$   | -   | 28  | 40   | mV            |
|             |   | $I_C = 10 \text{ A}; I_B = 1 \text{ A}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$    | -   | 250 | 400  | mV            |
|             |   | $I_C = 15 \text{ A}; I_B = 1.5 \text{ A}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$  | -   | 420 | 600  | mV            |
| $R_{CEsat}$ | collector-emitter saturation resistance |   | -   | 28  | 40   | m $\Omega$    |
| $V_{BEsat}$ | base-emitter saturation voltage         | $I_C = 1 \text{ A}; I_B = 50 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$   | -   | -   | 1    | V             |
|             |   | $I_C = 10 \text{ A}; I_B = 1 \text{ A}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$    | -   | -   | 1.35 | V             |
|             |   | $I_C = 15 \text{ A}; I_B = 1.5 \text{ A}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$  | -   | -   | 1.5  | V             |
| $V_{BEon}$  | base-emitter turn-on voltage            | $V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$   | -   | -   | 0.8  | V             |
| $t_d$       | delay time                              | $V_{CC} = 12.5 \text{ V}; I_C = 8 \text{ A}; I_{B(on)} = 250 \text{ mA}; I_{B(off)} = -250 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$         | -   | 20  | -    | ns            |
| $t_r$       | rise time                               |   | -   | 215 | -    | ns            |
| $t_{on}$    | turn-on time                            |   | -   | 235 | -    | ns            |
| $t_s$       | storage time                            |   | -   | 290 | -    | ns            |
| $t_f$       | fall time                               |   | -   | 125 | -    | ns            |
| $t_{off}$   | turn-off time                           |   | -   | 415 | -    | ns            |
| $f_T$       | transition frequency                    |   | $V_{CE} = 10 \text{ V}; I_C = 500 \text{ mA}; f = 100 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$ | -   | 105  | -             |
| $C_c$       | collector capacitance                   | $V_{CB} = 10 \text{ V}; I_E = 0 \text{ A}; i_e = 0 \text{ A}; f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$                               | -   | 90  | -    | pF            |



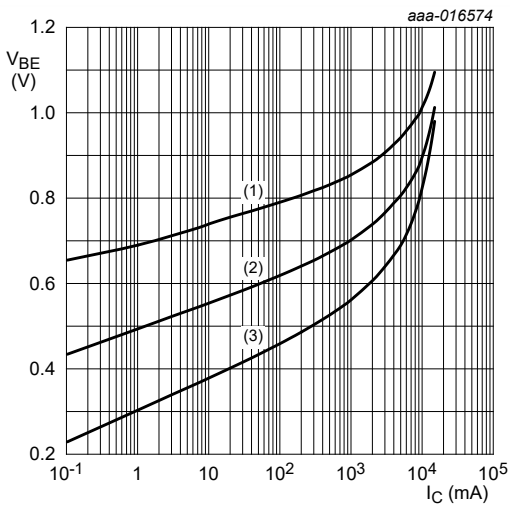
$V_{CE} = 2\text{ V}$   
 (1)  $T_{amb} = 100\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig. 4. DC current gain as a function of collector current; typical values**



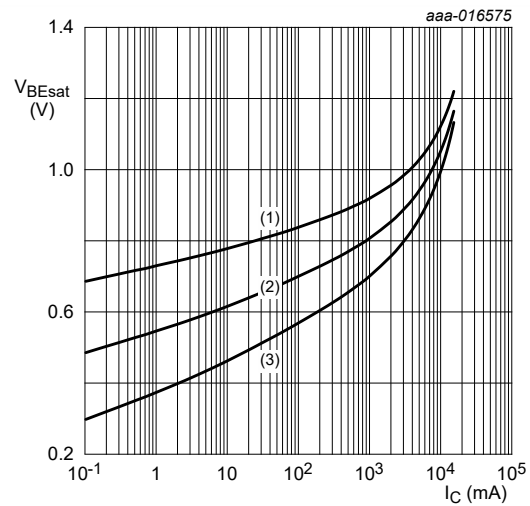
$T_{amb} = 25\text{ °C}$

**Fig. 5. Collector current as a function of collector-emitter voltage; typical values**



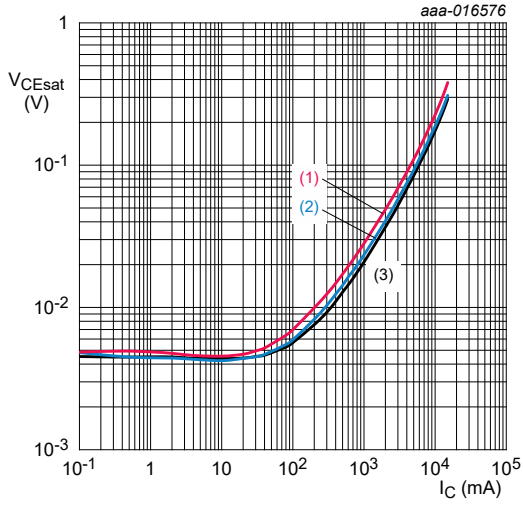
$V_{CE} = 2\text{ V}$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 100\text{ °C}$

**Fig. 6. Base-emitter voltage as a function of collector current; typical values**



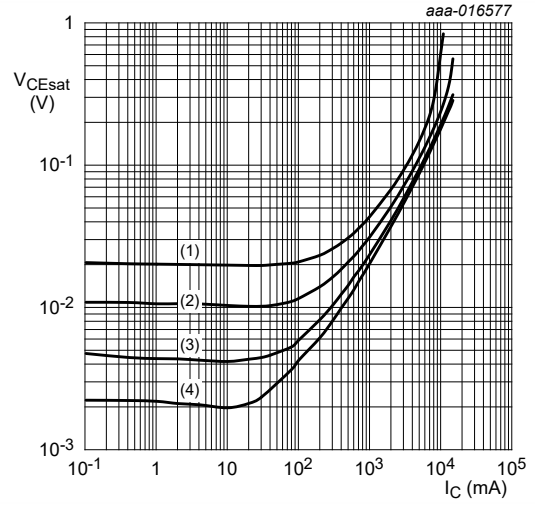
$I_C/I_B = 20$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 100\text{ °C}$

**Fig. 7. Base-emitter saturation voltage as a function of collector current; typical values**



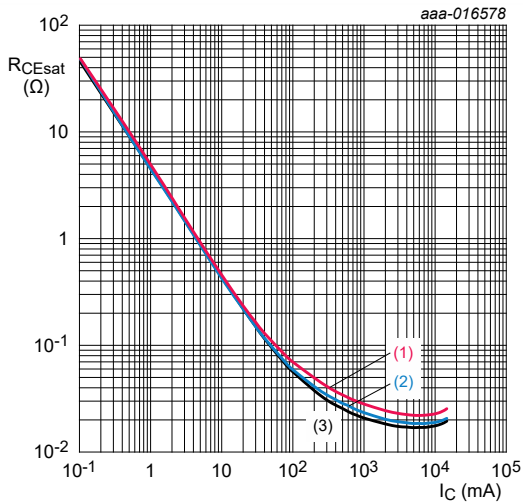
$I_C/I_B = 20$   
 (1)  $T_{amb} = 100\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values**



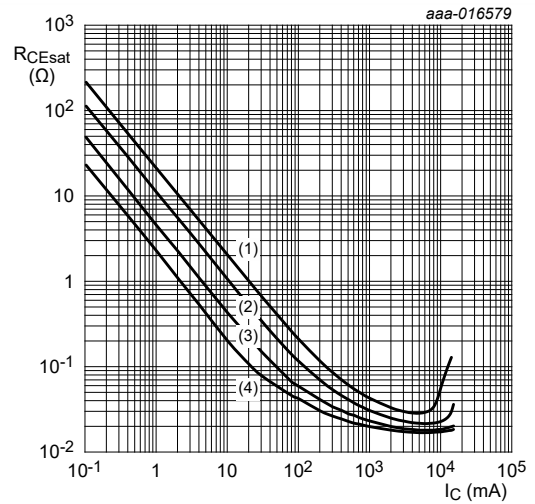
$T_{amb} = 25\text{ °C}$   
 (1)  $I_C/I_B = 100$   
 (2)  $I_C/I_B = 50$   
 (3)  $I_C/I_B = 20$   
 (4)  $I_C/I_B = 10$

**Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values**



$I_C/I_B = 20$   
 (1)  $T_{amb} = 100\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig. 10. Collector-emitter saturation resistance as a function of collector current; typical values**



$T_{amb} = 25\text{ °C}$   
 (1)  $I_C/I_B = 100$   
 (2)  $I_C/I_B = 50$   
 (3)  $I_C/I_B = 20$   
 (4)  $I_C/I_B = 10$

**Fig. 11. Collector-emitter saturation resistance as a function of collector current; typical values**

### 11. Test information

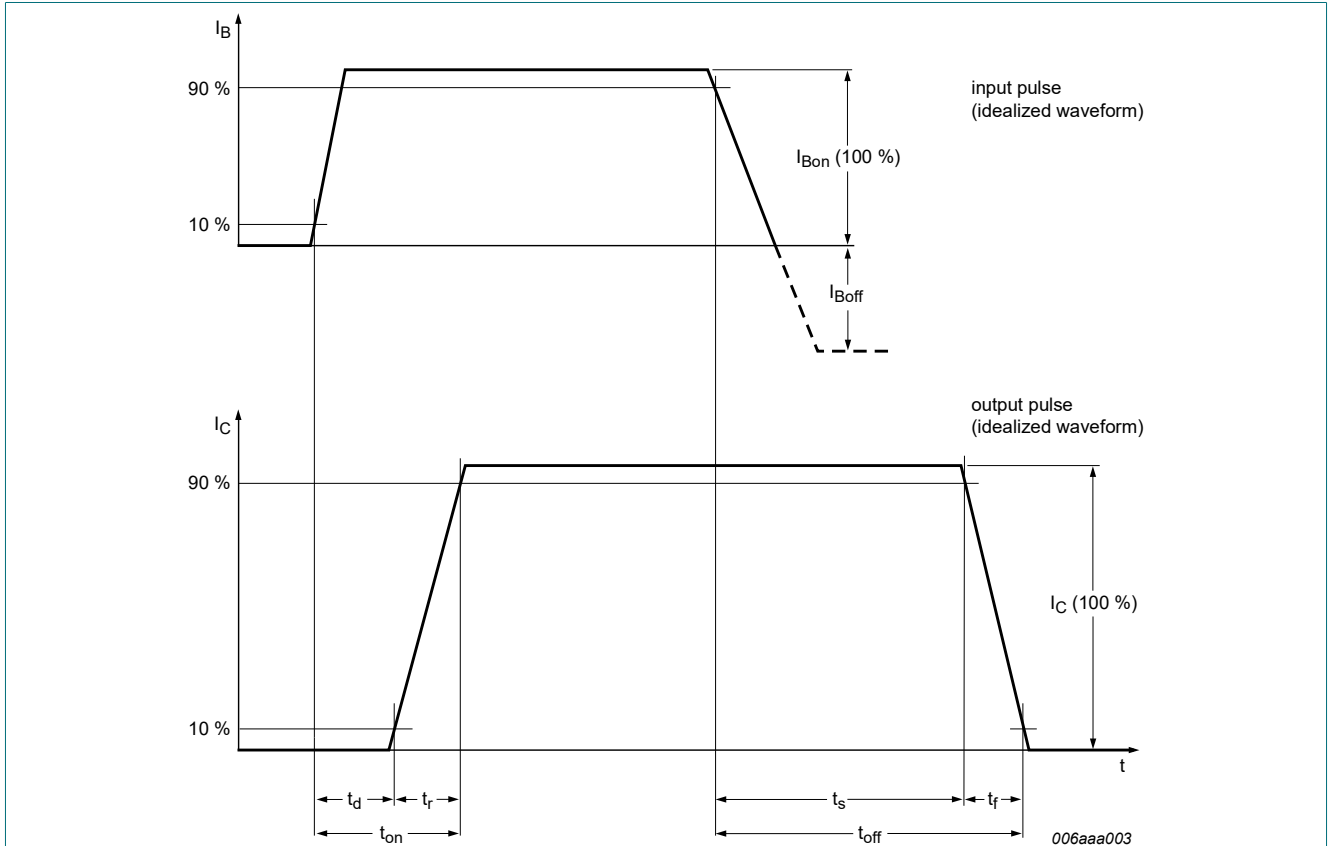


Fig. 12. Switching time definition

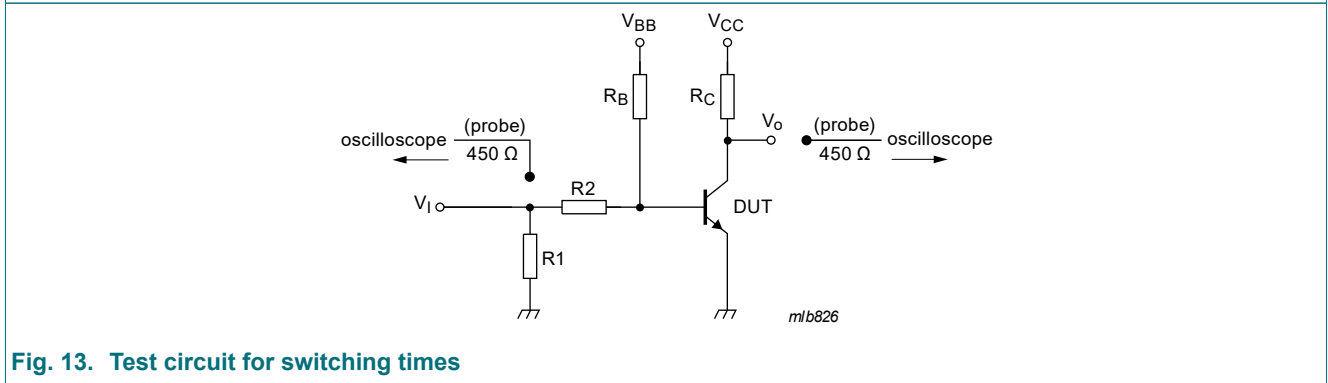


Fig. 13. Test circuit for switching times

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.



## 12. Package outline

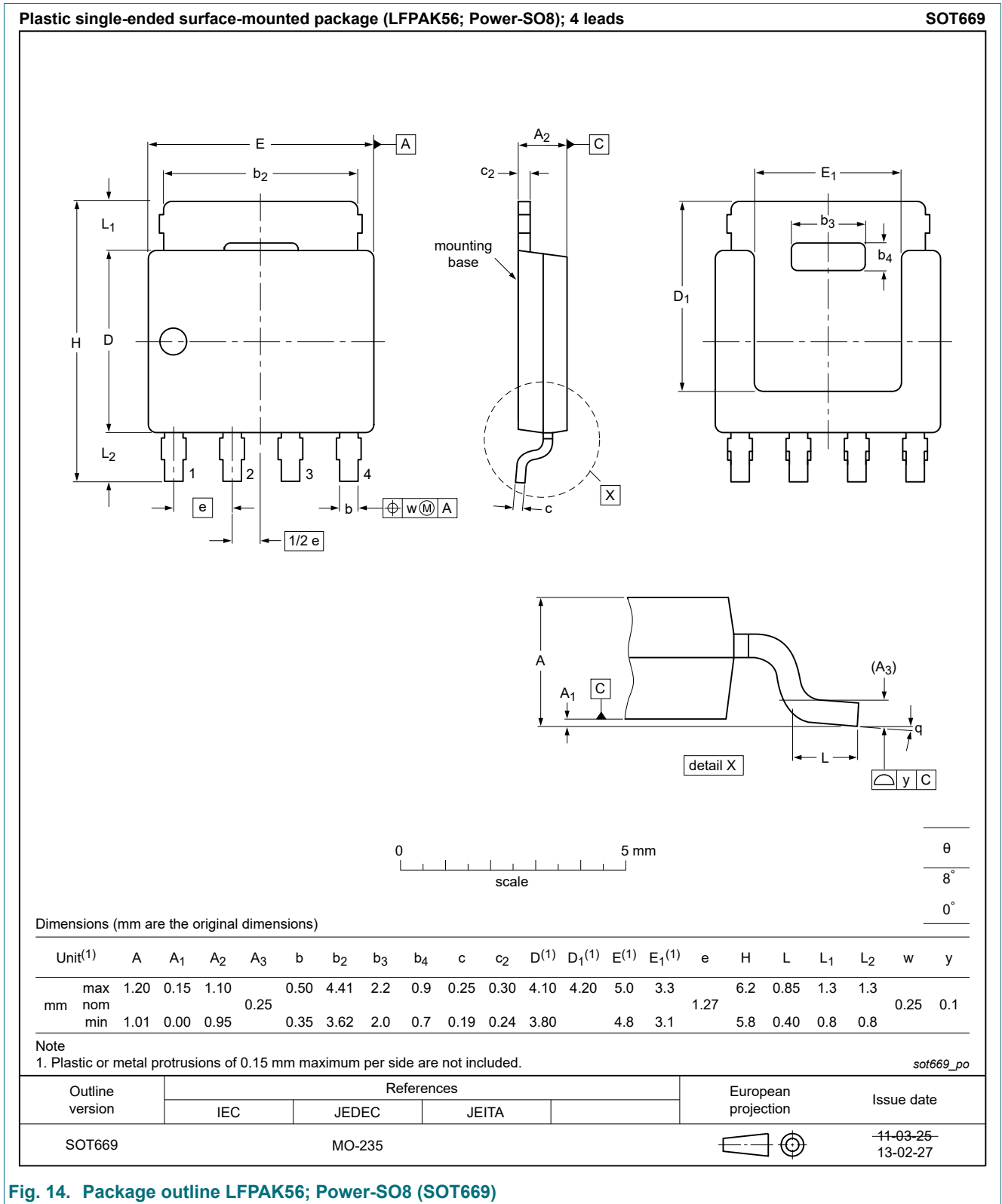


Fig. 14. Package outline LFAK56; Power-SO8 (SOT669)

### 13. Soldering

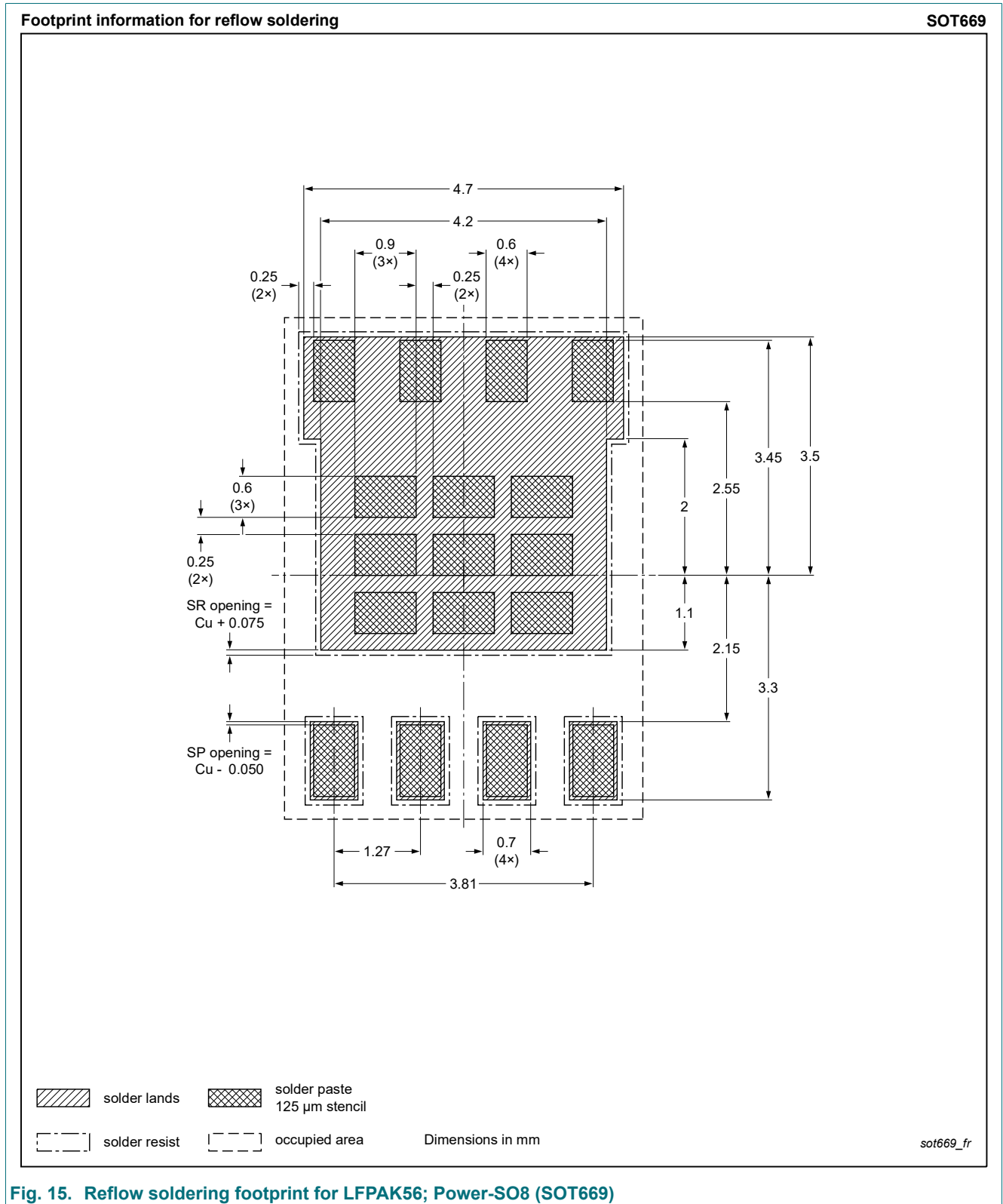
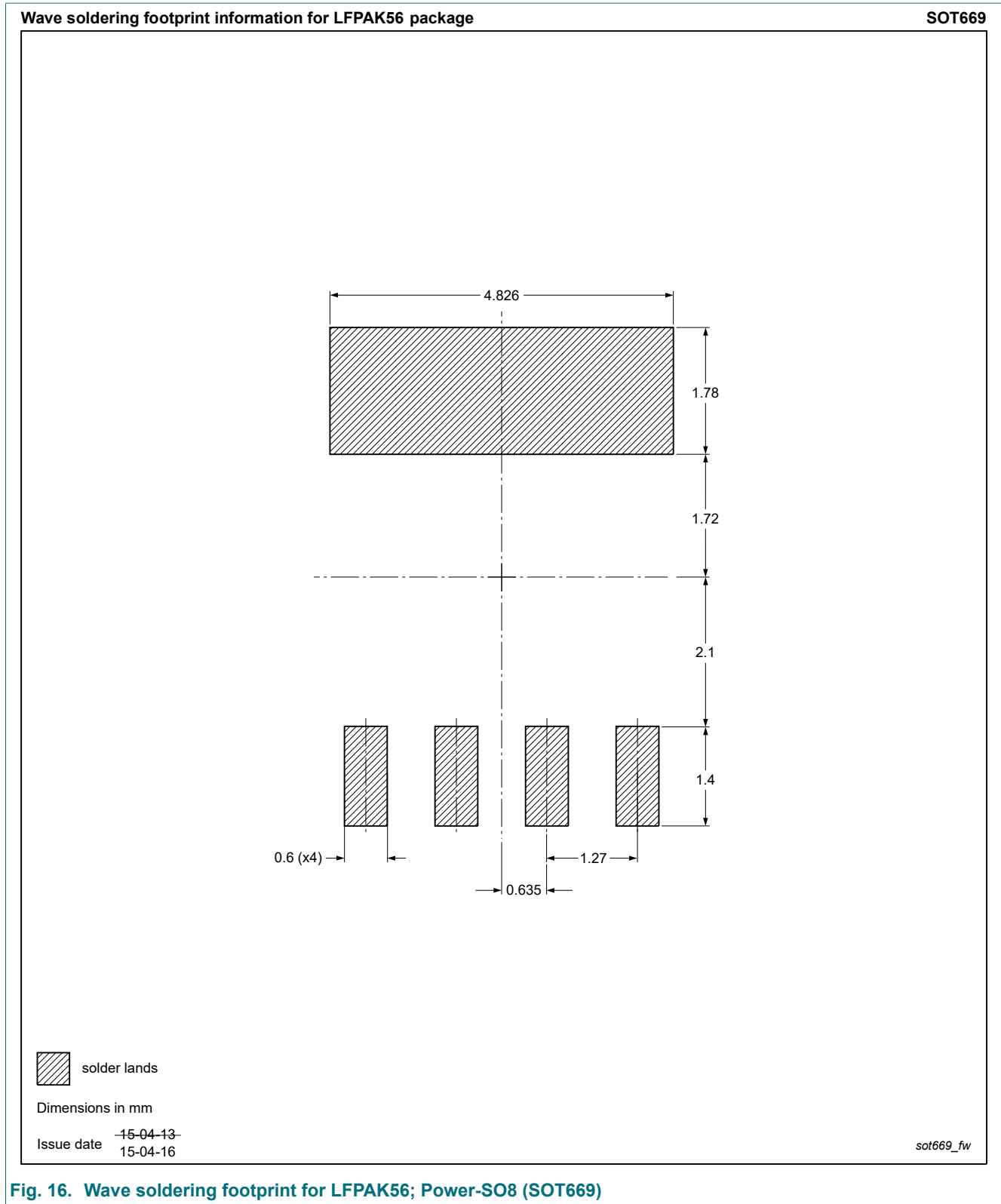


Fig. 15. Reflow soldering footprint for LFPAK56; Power-SO8 (SOT669)



## 14. Revision history

Table 8. Revision history

| Data sheet ID     | Release date | Data sheet status  | Change notice | Supersedes |
|-------------------|--------------|--------------------|---------------|------------|
| PHPT60415NY-Q v.1 | 20240927     | Product data sheet | -             | -          |

## 15. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 27 September 2024

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